600 WATT MULTI-LINE ULTRA LOW CAPACITANCE TVS ARRAY



DESCRIPTION

The PAM12SO824 is an ultra low capacitance TVS array that provides two line pairs of protection. This device protects automotive applications and is designed to minimize the effects of high overshoot voltage experienced during an ESD event. This device has an in-line design, which reduces lead inductance thus providing lower overshoot voltage.

The PAM12SO824 meets IEC 61000-4-2, IEC 61000-4-4 and IEC 61000-4-5 requirements. Packaged in an SO-8 configuration, this device is rated for 600 Watts Peak Pulse Power, for an $8/20\mu s$ waveform.

FEATURES

• AEC-Q101 Qualified

- Compatible with IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A 5/50ns
- Compatible with IEC 61000-4-5 (Surge): 24A, 8/20μs Level 2(Line-Gnd) & Level 3(Line-Line)
- 600 Watts Peak Pulse Power per Line (tp = 8/20μs)
- Protects up to Two Line Pairs
- Low Leakage Current < 1.0μA
- Ultra Low Capacitance: 3pF Typical
- RoHS Compliant
- REACH Compliant

MECHANICAL CHARACTERISTICS

- Molded JEDEC SO-8 Package
- Approximate Weight: 70 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:

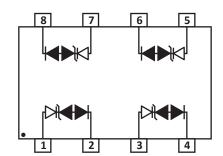
Pure-Tin - Sn, 100: 260-270°C

- 12mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

APPLICATIONS

• Automotive Applications

PIN CONFIGURATION



TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified								
PARAMETER	SYMBOL	VALUE	UNITS					
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P _{pp}	600	Watts					
Peak Pulse Current (tp = 8/20μs)	I _{pp}	30	Amps					
Lead Soldering Temperature	I _{FRM}	260	°C					
Operating Temperature	T _L	-55 to 150	°C					
Storage Temperature	T _{stg}	-55 to 150	°C					

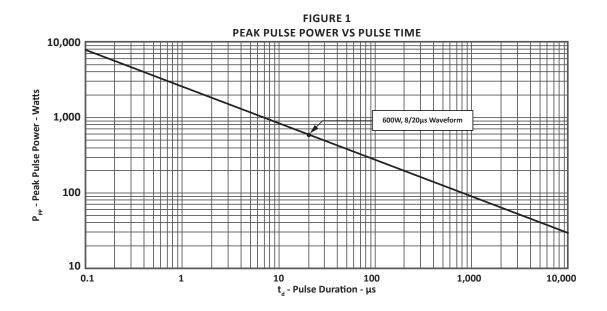
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified										
PART NUMBER (Note 1)	DEVICE MARKING	RATED STAND-OFF VOLTAGE (Note 1)	MINIMUM BREAK- DOWN VOLTAGE (Note 1)	MINIMUM SNAPBACK VOLTAGE (Note 1)	BACK CLAMPING LI TAGE VOLTAGE C					TYPICAL CAPACITANCE (Note 1)
		V _{wm} VOLTS	@1mA V _(BR) VOLTS	@I _{SB} = 50mA V _{SB} VOLTS	@I _{pp} = 2A @I _{pp} = 5A @I _{pp} = 24A @I _{pp} = 30A V _c V _c V _c VOLTS VOLTS VOLTS				@V _{wм} Ι _D μΑ	@0V, 1MHz C pF
PAM12SO824	SL4	2.8	3.0	2.8	5.5	8.5	15	21	1.0	3

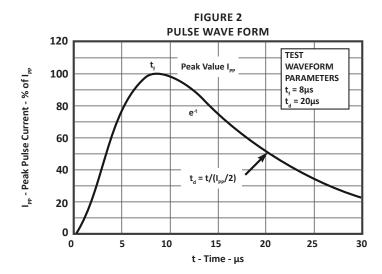
NOTES

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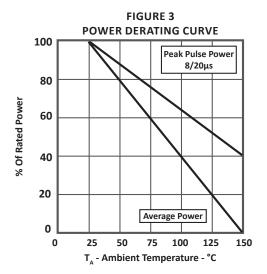
^{1.} Device measured between pin 1 to pin 2, pin 3 to pin 4, pin 5 to pin 6 and pin 7 to pin 8.

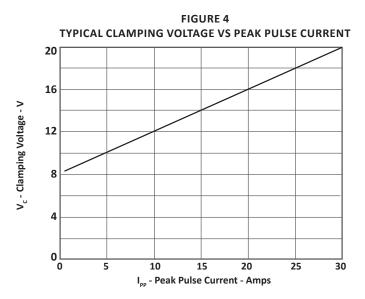
TYPICAL DEVICE CHARACTERISTICS





TYPICAL DEVICE CHARACTERISTICS





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APPLICATION INFORMATION

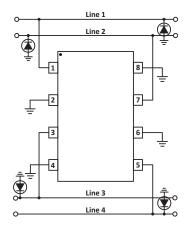


FIGURE 1 - BIDIRECTIONAL COMMON-MODE PROTECTION

The PAM12SO824 provides 4 lines of protection in a common mode configuration. Circuit connectivity is as follows:

- Line 1 connected to Pin 1.
- Line 2 connected to Pin 7.
- Line 3 connected to Pin 3.
- Line 4 connected to Pin 5.
- Pins 2, 4, 7 and 7 are connected to ground.
- External diode to ground is a low capacitance diode of less than 10pF.

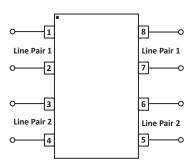


FIGURE 2 - BIDIRECTIONAL DIFFERENTIAL-MODE PROTECTION

The PAM12SO824 provides two line pairs in a differential mode configuration. Circuit connectivity is as follows:

- Line Pair 1 connected to Pins 1, 2, 7 and 8.
- Line Pair 2 connected to Pins 3, 4, 5 and 6.

CIRCUIT BOARD RECOMMENDATIONS

Circuit board layout is critical for electromagnetic compatibility protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

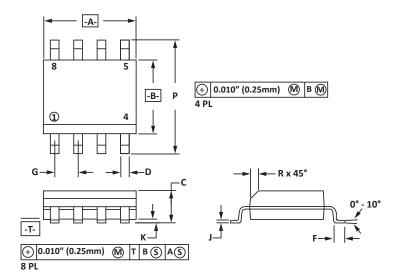


SO-8 PACKAGE INFORMATION

OUTLINE DIMENSIONS									
DIM	MILLIN	IETERS	INCHES						
	MIN	MAX	MIN	MAX					
А	4.80	5.00	0.189	0.196					
В	3.80	4.00	0.150	0.157					
С	1.35	1.75	0.054	0.068					
D	0.35	0.49	0.014	0.019					
F	0.40	1.25	0.016	0.049					
G	1.27	BSC	0.05	BSC					
J	0.18	0.25	0.007	0.009					
K	0.10	0.25	0.004	0.008					
Р	5.80	6.20	0.229	0.244					
R	0.25	0.50	0.010	0.019					

NOTES

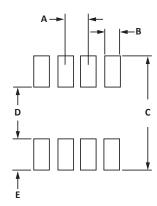
- 1. -T- = Seating plane and datum surface.
- 2. Dimensions "A" and "B" are datum.
- 3. Dimensions "A" and "B" do not include mold protrusion.
- 4. Maximum mold protrusion is 0.015" (0.380mm) per side.
- 5. Dimensioning and tolerances per ANSI Y14.5M, 1982.
- 6. Dimensions are exclusive of mold flash and metal burrs.



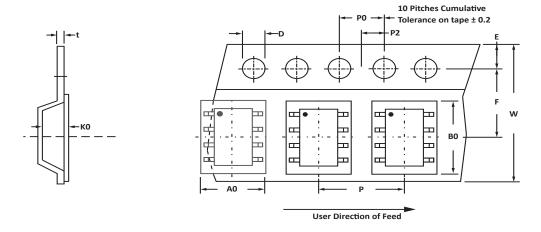
PAD LAYOUT DIMENSIONS									
DIM	MILLIN	IETERS	INCHES						
	MIN	MAX	MIN	MAX					
Α	1.14	1.40	0.045	0.055					
В	0.64	0.89	0.025	0.035					
С	6.22	-	0.245	-					
D	3.94	4.17	0.155	0.165					
Е	1.02	1.27	0.040	0.050					

NOTES

1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	P0	P2	Р	tmax
178mm (7")	12mm	6.50 ± 0.10	5.40 ± 0.10	2.00 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	5.50 ± 0.05	12.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	9.00 ± 0.10	0.25

NOTES

- 1. Dimensions are in millimeters.
- 2. Surface mount product is taped and reeled in accordance with EIA-481.
- 3. Suffix T7 = 7" Reel 1,000 pieces per 12mm tape.
- 4. Suffix T13 = 13" Reel 2,500 pieces per 12mm tape.
- 5. Bulk product shipped in tubes of 98 pieces per tube.
- 6. Marking on Part marking code (see page 2), date code, logo and pin one defined by dot on top of package.

ORDERING INFORMATION									
BASE PART NUMBER	NUMBER LEADFREE SUFFIX TAPE SUFFIX QTY/REEL REEL SIZE TUBE QT								
PAM12SO824	n/a	-T7	1,000	7"	98				
PAM12SO824	n/a	-T13	2,500	13"	98				
This device is only available in a Lead-Free configuration.									

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COMPANY INFORMATION

COMPANY PROFILE

In business more than 20 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products.

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